



Welcome to [E-XFL.COM](https://www.e-xfl.com)

## Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

## Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

### Details

|                                |                                                                                                                                                                                     |
|--------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Product Status                 | Obsolete                                                                                                                                                                            |
| Number of LABs/CLBs            | 160                                                                                                                                                                                 |
| Number of Logic Elements/Cells | 1280                                                                                                                                                                                |
| Total RAM Bits                 | 65536                                                                                                                                                                               |
| Number of I/O                  | 79                                                                                                                                                                                  |
| Number of Gates                | -                                                                                                                                                                                   |
| Voltage - Supply               | 1.14V ~ 1.26V                                                                                                                                                                       |
| Mounting Type                  | Surface Mount                                                                                                                                                                       |
| Operating Temperature          | 0°C ~ 85°C (TJ)                                                                                                                                                                     |
| Package / Case                 | 100-LQFP                                                                                                                                                                            |
| Supplier Device Package        | 100-TQFP (14x14)                                                                                                                                                                    |
| Purchase URL                   | <a href="https://www.e-xfl.com/product-detail/lattice-semiconductor/lcmxo2-1200ze-1tg100cr1">https://www.e-xfl.com/product-detail/lattice-semiconductor/lcmxo2-1200ze-1tg100cr1</a> |

---

## Introduction

The MachXO2 family of ultra low power, instant-on, non-volatile PLDs has six devices with densities ranging from 256 to 6864 Look-Up Tables (LUTs). In addition to LUT-based, low-cost programmable logic these devices feature Embedded Block RAM (EBR), Distributed RAM, User Flash Memory (UFM), Phase Locked Loops (PLLs), pre-engineered source synchronous I/O support, advanced configuration support including dual-boot capability and hardened versions of commonly used functions such as SPI controller, I<sup>2</sup>C controller and timer/counter. These features allow these devices to be used in low cost, high volume consumer and system applications.

The MachXO2 devices are designed on a 65 nm non-volatile low power process. The device architecture has several features such as programmable low swing differential I/Os and the ability to turn off I/O banks, on-chip PLLs and oscillators dynamically. These features help manage static and dynamic power consumption resulting in low static power for all members of the family.

The MachXO2 devices are available in two versions – ultra low power (ZE) and high performance (HC and HE) devices. The ultra low power devices are offered in three speed grades –1, –2 and –3, with –3 being the fastest. Similarly, the high-performance devices are offered in three speed grades: –4, –5 and –6, with –6 being the fastest. HC devices have an internal linear voltage regulator which supports external V<sub>CC</sub> supply voltages of 3.3 V or 2.5 V. ZE and HE devices only accept 1.2 V as the external V<sub>CC</sub> supply voltage. With the exception of power supply voltage all three types of devices (ZE, HC and HE) are functionally compatible and pin compatible with each other.

The MachXO2 PLDs are available in a broad range of advanced halogen-free packages ranging from the space saving 2.5 mm x 2.5 mm WLCSP to the 23 mm x 23 mm fpBGA. MachXO2 devices support density migration within the same package. Table 1-1 shows the LUT densities, package and I/O options, along with other key parameters.

The pre-engineered source synchronous logic implemented in the MachXO2 device family supports a broad range of interface standards, including LPDDR, DDR, DDR2 and 7:1 gearing for display I/Os.

The MachXO2 devices offer enhanced I/O features such as drive strength control, slew rate control, PCI compatibility, bus-keeper latches, pull-up resistors, pull-down resistors, open drain outputs and hot socketing. Pull-up, pull-down and bus-keeper features are controllable on a “per-pin” basis.

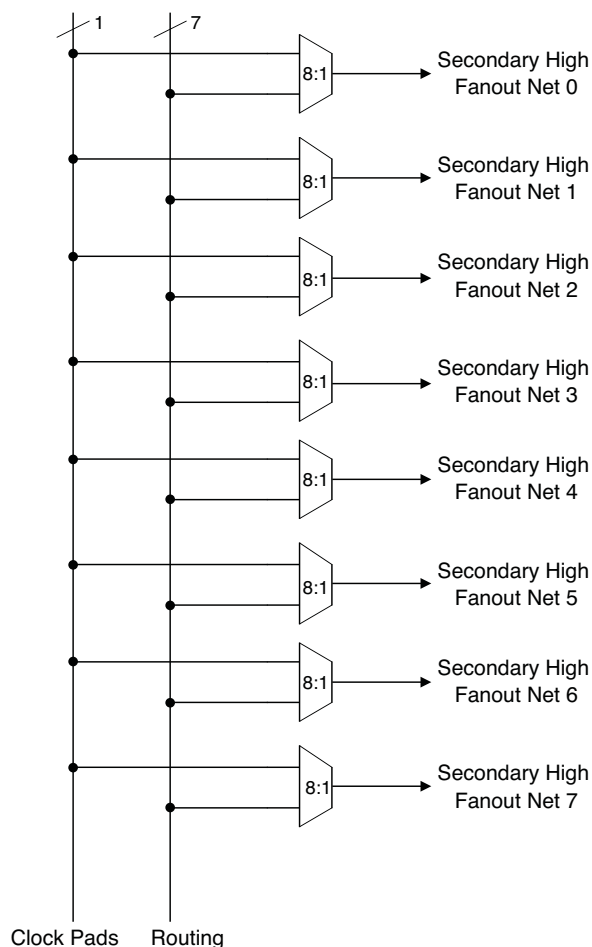
A user-programmable internal oscillator is included in MachXO2 devices. The clock output from this oscillator may be divided by the timer/counter for use as clock input in functions such as LED control, key-board scanner and similar state machines.

The MachXO2 devices also provide flexible, reliable and secure configuration from on-chip Flash memory. These devices can also configure themselves from external SPI Flash or be configured by an external master through the JTAG test access port or through the I<sup>2</sup>C port. Additionally, MachXO2 devices support dual-boot capability (using external Flash memory) and remote field upgrade (TransFR) capability.

Lattice provides a variety of design tools that allow complex designs to be efficiently implemented using the MachXO2 family of devices. Popular logic synthesis tools provide synthesis library support for MachXO2. Lattice design tools use the synthesis tool output along with the user-specified preferences and constraints to place and route the design in the MachXO2 device. These tools extract the timing from the routing and back-annotate it into the design for timing verification.

Lattice provides many pre-engineered IP (Intellectual Property) LatticeCORE™ modules, including a number of reference designs licensed free of charge, optimized for the MachXO2 PLD family. By using these configurable soft core IP cores as standardized blocks, users are free to concentrate on the unique aspects of their design, increasing their productivity.

**Figure 2-6. Secondary High Fanout Nets for MachXO2 Devices**



## sysCLOCK Phase Locked Loops (PLLs)

The sysCLOCK PLLs provide the ability to synthesize clock frequencies. The MachXO2-640U, MachXO2-1200/U and larger devices have one or more sysCLOCK PLL. CLKI is the reference frequency input to the PLL and its source can come from an external I/O pin or from internal routing. CLKFB is the feedback signal to the PLL which can come from internal routing or an external I/O pin. The feedback divider is used to multiply the reference frequency and thus synthesize a higher frequency clock output.

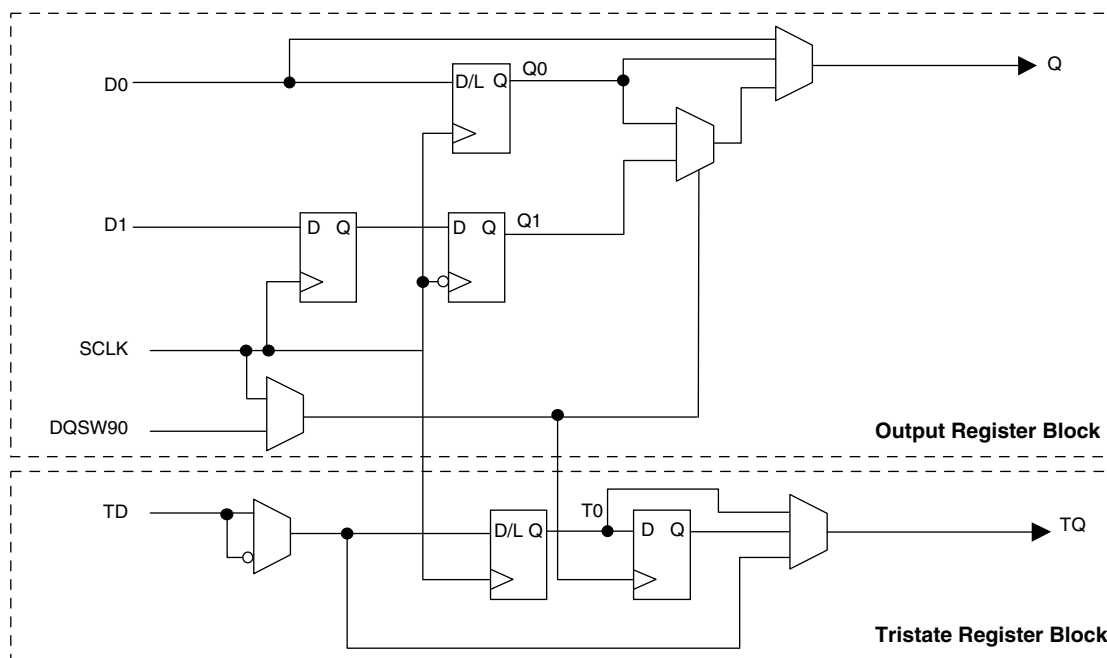
The MachXO2 sysCLOCK PLLs support high resolution (16-bit) fractional-N synthesis. Fractional-N frequency synthesis allows the user to generate an output clock which is a non-integer multiple of the input frequency. For more information about using the PLL with Fractional-N synthesis, please see TN1199, [MachXO2 sysCLOCK PLL Design and Usage Guide](#).

Each output has its own output divider, thus allowing the PLL to generate different frequencies for each output. The output dividers can have a value from 1 to 128. The output dividers may also be cascaded together to generate low frequency clocks. The CLKOP, CLKOS, CLKOS2, and CLKOS3 outputs can all be used to drive the MachXO2 clock distribution network directly or general purpose routing resources can be used.

The LOCK signal is asserted when the PLL determines it has achieved lock and de-asserted if a loss of lock is detected. A block diagram of the PLL is shown in Figure 2-7.

The setup and hold times of the device can be improved by programming a phase shift into the CLKOS, CLKOS2, and CLKOS3 output clocks which will advance or delay the output clock with reference to the CLKOP output clock.

**Figure 2-15. MachXO2 Output Register Block Diagram (PIO on the Right Edges)**



### Tri-state Register Block

The tri-state register block registers tri-state control signals from the core of the device before they are passed to the sysIO buffers. The block contains a register for SDR operation. In SDR, TD input feeds one of the flip-flops that then feeds the output.

The tri-state register blocks on the right edge contain an additional register for DDR memory operation. In DDR memory mode, the register TS input is fed into another register that is clocked using the DQSW90 signal. The output of this register is used as a tri-state control.

### Input Gearbox

Each PIC on the bottom edge has a built-in 1:8 input gearbox. Each of these input gearboxes may be programmed as a 1:7 de-serializer or as one IDDRX4 (1:8) gearbox or as two IDDRX2 (1:4) gearboxes. Table 2-9 shows the gearbox signals.

**Table 2-9. Input Gearbox Signal List**

| Name      | I/O Type | Description                                                                                                                                             |
|-----------|----------|---------------------------------------------------------------------------------------------------------------------------------------------------------|
| D         | Input    | High-speed data input after programmable delay in PIO A input register block                                                                            |
| ALIGNWD   | Input    | Data alignment signal from device core                                                                                                                  |
| SCLK      | Input    | Slow-speed system clock                                                                                                                                 |
| ECLK[1:0] | Input    | High-speed edge clock                                                                                                                                   |
| RST       | Input    | Reset                                                                                                                                                   |
| Q[7:0]    | Output   | Low-speed data to device core:<br>Video RX(1:7): Q[6:0]<br>GDDR4(1:8): Q[7:0]<br>GDDR2(1:4)(IOL-A): Q4, Q5, Q6, Q7<br>GDDR2(1:4)(IOL-C): Q0, Q1, Q2, Q3 |

---

## DDR Memory Support

Certain PICs on the right edge of MachXO2-640U, MachXO2-1200/U and larger devices, have additional circuitry to allow the implementation of DDR memory interfaces. There are two groups of 14 or 12 PIOs each on the right edge with additional circuitry to implement DDR memory interfaces. This capability allows the implementation of up to 16-bit wide memory interfaces. One PIO from each group contains a control element, the DQS Read/Write Block, to facilitate the generation of clock and control signals (DQSR90, DQSW90, DDRCLKPOL and DATAVALID). These clock and control signals are distributed to the other PIO in the group through dedicated low skew routing.

### DQS Read Write Block

Source synchronous interfaces generally require the input clock to be adjusted in order to correctly capture data at the input register. For most interfaces a PLL is used for this adjustment. However, in DDR memories the clock (referred to as DQS) is not free-running so this approach cannot be used. The DQS Read Write block provides the required clock alignment for DDR memory interfaces. DQSR90 and DQSW90 signals are generated by the DQS Read Write block from the DQS input.

In a typical DDR memory interface design, the phase relationship between the incoming delayed DQS strobe and the internal system clock (during the read cycle) is unknown. The MachXO2 family contains dedicated circuits to transfer data between these domains. To prevent set-up and hold violations, at the domain transfer between DQS (delayed) and the system clock, a clock polarity selector is used. This circuit changes the edge on which the data is registered in the synchronizing registers in the input register block. This requires evaluation at the start of each read cycle for the correct clock polarity. Prior to the read operation in DDR memories, DQS is in tri-state (pulled by termination). The DDR memory device drives DQS low at the start of the preamble state. A dedicated circuit in the DQS Read Write block detects the first DQS rising edge after the preamble state and generates the DDRCLKPOL signal. This signal is used to control the polarity of the clock to the synchronizing registers.

The temperature, voltage and process variations of the DQS delay block are compensated by a set of calibration signals (6-bit bus) from a DLL on the right edge of the device. The DLL loop is compensated for temperature, voltage and process variations by the system clock and feedback loop.

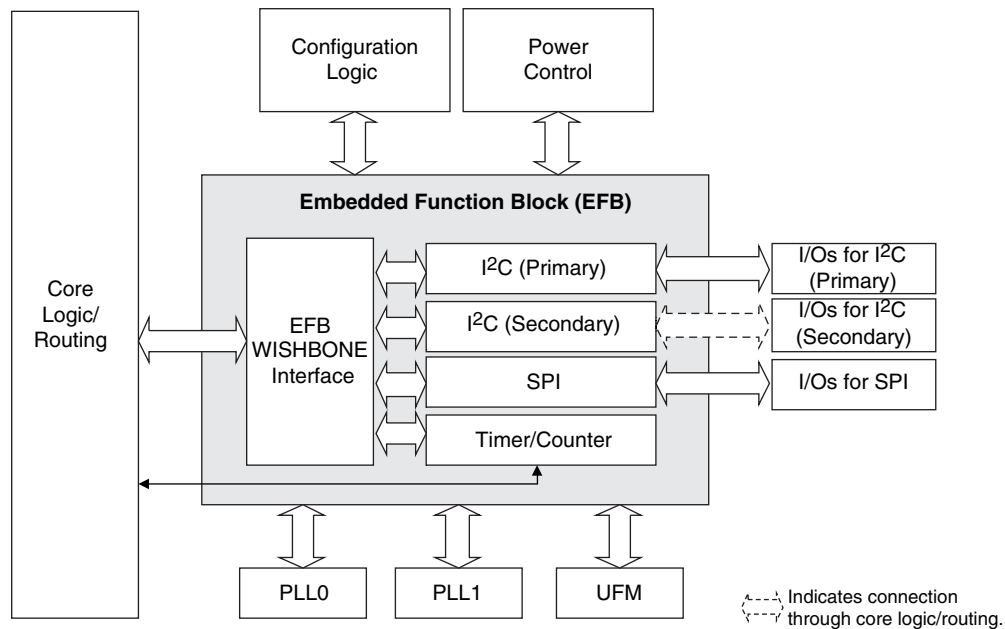
### sysIO Buffer

Each I/O is associated with a flexible buffer referred to as a sysIO buffer. These buffers are arranged around the periphery of the device in groups referred to as banks. The sysIO buffers allow users to implement a wide variety of standards that are found in today's systems including LVCMOS, TTL, PCI, SSTL, HSTL, LVDS, BLVDS, MLVDS and LVPECL.

Each bank is capable of supporting multiple I/O standards. In the MachXO2 devices, single-ended output buffers, ratioed input buffers (LVTTL, LVCMOS and PCI), differential (LVDS) and referenced input buffers (SSTL and HSTL) are powered using I/O supply voltage ( $V_{CCIO}$ ). Each sysIO bank has its own  $V_{CCIO}$ . In addition, each bank has a voltage reference,  $V_{REF}$  which allows the use of referenced input buffers independent of the bank  $V_{CCIO}$ .

MachXO2-256 and MachXO2-640 devices contain single-ended ratioed input buffers and single-ended output buffers with complementary outputs on all the I/O banks. Note that the single-ended input buffers on these devices do not contain PCI clamps. In addition to the single-ended I/O buffers these two devices also have differential and referenced input buffers on all I/Os. The I/Os are arranged in pairs, the two pads in the pair are described as "T" and "C", where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

**Figure 2-20. Embedded Function Block Interface**



## Hardened I<sup>2</sup>C IP Core

Every MachXO2 device contains two I<sup>2</sup>C IP cores. These are the primary and secondary I<sup>2</sup>C IP cores. Either of the two cores can be configured either as an I<sup>2</sup>C master or as an I<sup>2</sup>C slave. The only difference between the two IP cores is that the primary core has pre-assigned I/O pins whereas users can assign I/O pins for the secondary core.

When the IP core is configured as a master it will be able to control other devices on the I<sup>2</sup>C bus through the interface. When the core is configured as the slave, the device will be able to provide I/O expansion to an I<sup>2</sup>C Master. The I<sup>2</sup>C cores support the following functionality:

- Master and Slave operation
- 7-bit and 10-bit addressing
- Multi-master arbitration support
- Up to 400 kHz data transfer speed
- General call support
- Interface to custom logic through 8-bit WISHBONE interface

**Figure 2-21. I<sup>2</sup>C Core Block Diagram**

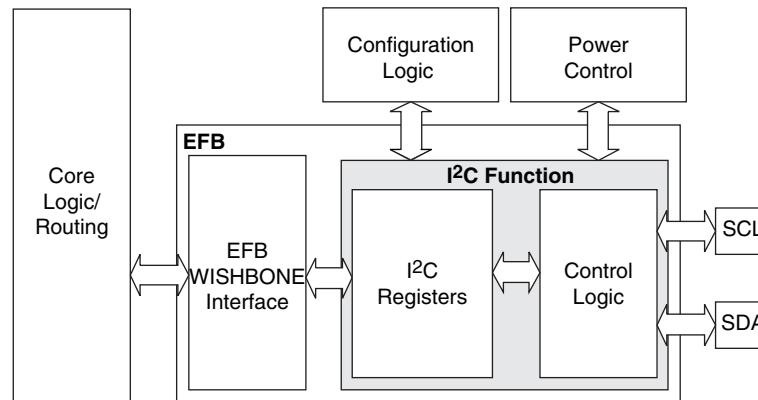


Table 2-15 describes the signals interfacing with the I<sup>2</sup>C cores.

**Table 2-15. I<sup>2</sup>C Core Signal Description**

| Signal Name | I/O            | Description                                                                                                                                                                                                                                                                                                                                                                                                                     |
|-------------|----------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| i2c_scl     | Bi-directional | Bi-directional clock line of the I <sup>2</sup> C core. The signal is an output if the I <sup>2</sup> C core is in master mode. The signal is an input if the I <sup>2</sup> C core is in slave mode. MUST be routed directly to the pre-assigned I/O of the chip. Refer to the Pinout Information section of this document for detailed pad and pin locations of I <sup>2</sup> C ports in each MachXO2 device.                |
| i2c_sda     | Bi-directional | Bi-directional data line of the I <sup>2</sup> C core. The signal is an output when data is transmitted from the I <sup>2</sup> C core. The signal is an input when data is received into the I <sup>2</sup> C core. MUST be routed directly to the pre-assigned I/O of the chip. Refer to the Pinout Information section of this document for detailed pad and pin locations of I <sup>2</sup> C ports in each MachXO2 device. |
| i2c_irqo    | Output         | Interrupt request output signal of the I <sup>2</sup> C core. The intended usage of this signal is for it to be connected to the WISHBONE master controller (i.e. a microcontroller or state machine) and request an interrupt when a specific condition is met. These conditions are described with the I <sup>2</sup> C register definitions.                                                                                 |
| cfg_wake    | Output         | Wake-up signal – To be connected only to the power module of the MachXO2 device. The signal is enabled only if the “Wakeup Enable” feature has been set within the EFB GUI, I <sup>2</sup> C Tab.                                                                                                                                                                                                                               |
| cfg_stdby   | Output         | Stand-by signal – To be connected only to the power module of the MachXO2 device. The signal is enabled only if the “Wakeup Enable” feature has been set within the EFB GUI, I <sup>2</sup> C Tab.                                                                                                                                                                                                                              |

## Hardened SPI IP Core

Every MachXO2 device has a hard SPI IP core that can be configured as a SPI master or slave. When the IP core is configured as a master it will be able to control other SPI enabled chips connected to the SPI bus. When the core is configured as the slave, the device will be able to interface to an external SPI master. The SPI IP core on MachXO2 devices supports the following functions:

- Configurable Master and Slave modes
- Full-Duplex data transfer
- Mode fault error flag with CPU interrupt capability
- Double-buffered data register
- Serial clock with programmable polarity and phase
- LSB First or MSB First Data Transfer
- Interface to custom logic through 8-bit WISHBONE interface

### DC Electrical Characteristics

#### Over Recommended Operating Conditions

| Symbol                 | Parameter                                          | Condition                                                                                          | Min.           | Typ. | Max.           | Units   |
|------------------------|----------------------------------------------------|----------------------------------------------------------------------------------------------------|----------------|------|----------------|---------|
| $I_{IL}, I_{IH}^{1,4}$ | Input or I/O Leakage                               | Clamp OFF and $V_{CCIO} < V_{IN} < V_{IH} (MAX)$                                                   | —              | —    | +175           | $\mu A$ |
|                        |                                                    | Clamp OFF and $V_{IN} = V_{CCIO}$                                                                  | -10            | —    | 10             | $\mu A$ |
|                        |                                                    | Clamp OFF and $V_{CCIO} - 0.97 V < V_{IN} < V_{CCIO}$                                              | -175           | —    | —              | $\mu A$ |
|                        |                                                    | Clamp OFF and $0 V < V_{IN} < V_{CCIO} - 0.97 V$                                                   | —              | —    | 10             | $\mu A$ |
|                        |                                                    | Clamp OFF and $V_{IN} = GND$                                                                       | —              | —    | 10             | $\mu A$ |
|                        |                                                    | Clamp ON and $0 V < V_{IN} < V_{CCIO}$                                                             | —              | —    | 10             | $\mu A$ |
| $I_{PU}$               | I/O Active Pull-up Current                         | $0 < V_{IN} < 0.7 V_{CCIO}$                                                                        | -30            | —    | -309           | $\mu A$ |
| $I_{PD}$               | I/O Active Pull-down Current                       | $V_{IL} (MAX) < V_{IN} < V_{CCIO}$                                                                 | 30             | —    | 305            | $\mu A$ |
| $I_{BHLS}$             | Bus Hold Low sustaining current                    | $V_{IN} = V_{IL} (MAX)$                                                                            | 30             | —    | —              | $\mu A$ |
| $I_{BHHS}$             | Bus Hold High sustaining current                   | $V_{IN} = 0.7 V_{CCIO}$                                                                            | -30            | —    | —              | $\mu A$ |
| $I_{BHLO}$             | Bus Hold Low Overdrive current                     | $0 \leq V_{IN} \leq V_{CCIO}$                                                                      | —              | —    | 305            | $\mu A$ |
| $I_{BHHO}$             | Bus Hold High Overdrive current                    | $0 \leq V_{IN} \leq V_{CCIO}$                                                                      | —              | —    | -309           | $\mu A$ |
| $V_{BHT}^3$            | Bus Hold Trip Points                               |                                                                                                    | $V_{IL} (MAX)$ | —    | $V_{IH} (MIN)$ | V       |
| C1                     | I/O Capacitance <sup>2</sup>                       | $V_{CCIO} = 3.3 V, 2.5 V, 1.8 V, 1.5 V, 1.2 V, V_{CC} = Typ., V_{IO} = 0 \text{ to } V_{IH} (MAX)$ | 3              | 5    | 9              | pF      |
| C2                     | Dedicated Input Capacitance <sup>2</sup>           | $V_{CCIO} = 3.3 V, 2.5 V, 1.8 V, 1.5 V, 1.2 V, V_{CC} = Typ., V_{IO} = 0 \text{ to } V_{IH} (MAX)$ | 3              | 5.5  | 7              | pF      |
| $V_{HYST}$             | Hysteresis for Schmitt Trigger Inputs <sup>5</sup> | $V_{CCIO} = 3.3 V, \text{Hysteresis} = \text{Large}$                                               | —              | 450  | —              | mV      |
|                        |                                                    | $V_{CCIO} = 2.5 V, \text{Hysteresis} = \text{Large}$                                               | —              | 250  | —              | mV      |
|                        |                                                    | $V_{CCIO} = 1.8 V, \text{Hysteresis} = \text{Large}$                                               | —              | 125  | —              | mV      |
|                        |                                                    | $V_{CCIO} = 1.5 V, \text{Hysteresis} = \text{Large}$                                               | —              | 100  | —              | mV      |
|                        |                                                    | $V_{CCIO} = 3.3 V, \text{Hysteresis} = \text{Small}$                                               | —              | 250  | —              | mV      |
|                        |                                                    | $V_{CCIO} = 2.5 V, \text{Hysteresis} = \text{Small}$                                               | —              | 150  | —              | mV      |
|                        |                                                    | $V_{CCIO} = 1.8 V, \text{Hysteresis} = \text{Small}$                                               | —              | 60   | —              | mV      |
|                        |                                                    | $V_{CCIO} = 1.5 V, \text{Hysteresis} = \text{Small}$                                               | —              | 40   | —              | mV      |

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.
2.  $T_A = 25^\circ C, f = 1.0 \text{ MHz}$ .
3. Please refer to  $V_{IL}$  and  $V_{IH}$  in the sysIO Single-Ended DC Electrical Characteristics table of this document.
4. When  $V_{IH}$  is higher than  $V_{CCIO}$ , a transient current typically of 30 ns in duration or less with a peak current of 6 mA can occur on the high-to-low transition. For true LVDS output pins in MachXO2-640U, MachXO2-1200/U and larger devices,  $V_{IH}$  must be less than or equal to  $V_{CCIO}$ .
5. With bus keeper circuit turned on. For more details, refer to TN1202, [MachXO2 sysIO Usage Guide](#).



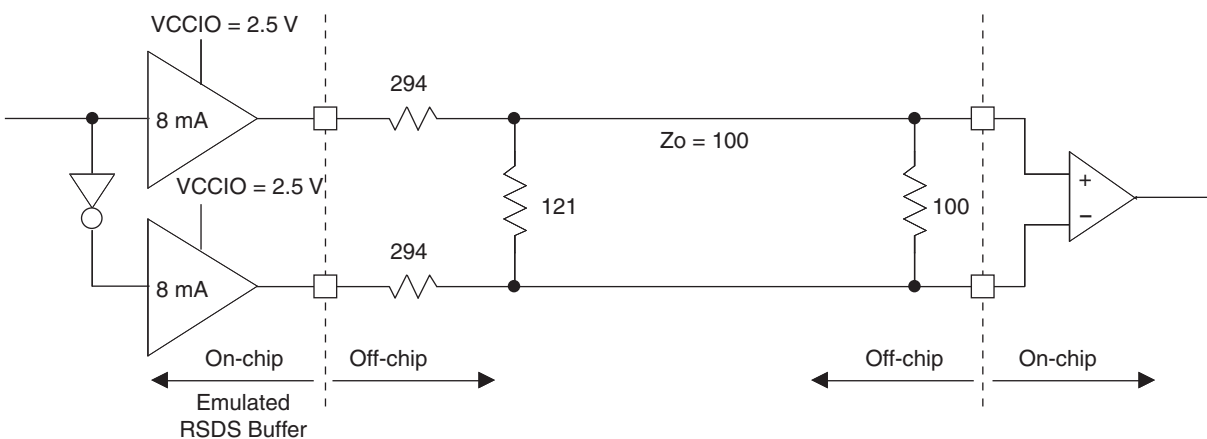
**sysIO Single-Ended DC Electrical Characteristics<sup>1, 2</sup>**

| Input/Output Standard | $V_{IL}$              |                   | $V_{IH}$          |          | $V_{OL}$ Max. (V) | $V_{OH}$ Min. (V) | $I_{OL}$ Max. <sup>4</sup> (mA) | $I_{OH}$ Max. <sup>4</sup> (mA) |
|-----------------------|-----------------------|-------------------|-------------------|----------|-------------------|-------------------|---------------------------------|---------------------------------|
|                       | Min. (V) <sup>3</sup> | Max. (V)          | Min. (V)          | Max. (V) |                   |                   |                                 |                                 |
| LVCMOS 3.3 LVTTL      | -0.3                  | 0.8               | 2.0               | 3.6      | 0.4               | $V_{CCIO} - 0.4$  | 4                               | -4                              |
|                       |                       |                   |                   |          |                   |                   | 8                               | -8                              |
|                       |                       |                   |                   |          |                   |                   | 12                              | -12                             |
|                       |                       |                   |                   |          |                   |                   | 16                              | -16                             |
|                       |                       |                   |                   |          |                   |                   | 24                              | -24                             |
|                       |                       |                   |                   |          | 0.2               | $V_{CCIO} - 0.2$  | 0.1                             | -0.1                            |
| LVCMOS 2.5            | -0.3                  | 0.7               | 1.7               | 3.6      | 0.4               | $V_{CCIO} - 0.4$  | 4                               | -4                              |
|                       |                       |                   |                   |          |                   |                   | 8                               | -8                              |
|                       |                       |                   |                   |          |                   |                   | 12                              | -12                             |
|                       |                       |                   |                   |          |                   |                   | 16                              | -16                             |
|                       |                       |                   |                   |          | 0.2               | $V_{CCIO} - 0.2$  | 0.1                             | -0.1                            |
| LVCMOS 1.8            | -0.3                  | $0.35V_{CCIO}$    | $0.65V_{CCIO}$    | 3.6      | 0.4               | $V_{CCIO} - 0.4$  | 4                               | -4                              |
|                       |                       |                   |                   |          |                   |                   | 8                               | -8                              |
|                       |                       |                   |                   |          |                   |                   | 12                              | -12                             |
|                       |                       |                   |                   |          | 0.2               | $V_{CCIO} - 0.2$  | 0.1                             | -0.1                            |
| LVCMOS 1.5            | -0.3                  | $0.35V_{CCIO}$    | $0.65V_{CCIO}$    | 3.6      | 0.4               | $V_{CCIO} - 0.4$  | 4                               | -4                              |
|                       |                       |                   |                   |          | 0.2               | $V_{CCIO} - 0.2$  | 8                               | -8                              |
|                       |                       |                   |                   |          |                   |                   | 12                              | -12                             |
| LVCMOS 1.2            | -0.3                  | $0.35V_{CCIO}$    | $0.65V_{CCIO}$    | 3.6      | 0.4               | $V_{CCIO} - 0.4$  | 4                               | -2                              |
|                       |                       |                   |                   |          |                   |                   | 8                               | -6                              |
|                       |                       |                   |                   |          |                   |                   | 0.1                             | -0.1                            |
|                       |                       |                   |                   |          | 0.2               | $V_{CCIO} - 0.2$  | 0.1                             | -0.1                            |
| PCI                   | -0.3                  | $0.3V_{CCIO}$     | $0.5V_{CCIO}$     | 3.6      | $0.1V_{CCIO}$     | $0.9V_{CCIO}$     | 1.5                             | -0.5                            |
| SSTL25 Class I        | -0.3                  | $V_{REF} - 0.18$  | $V_{REF} + 0.18$  | 3.6      | 0.54              | $V_{CCIO} - 0.62$ | 8                               | 8                               |
| SSTL25 Class II       | -0.3                  | $V_{REF} - 0.18$  | $V_{REF} + 0.18$  | 3.6      | NA                | NA                | NA                              | NA                              |
| SSTL18 Class I        | -0.3                  | $V_{REF} - 0.125$ | $V_{REF} + 0.125$ | 3.6      | 0.40              | $V_{CCIO} - 0.40$ | 8                               | 8                               |
| SSTL18 Class II       | -0.3                  | $V_{REF} - 0.125$ | $V_{REF} + 0.125$ | 3.6      | NA                | NA                | NA                              | NA                              |
| HSTL18 Class I        | -0.3                  | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | 3.6      | 0.40              | $V_{CCIO} - 0.40$ | 8                               | 8                               |
| HSTL18 Class II       | -0.3                  | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | 3.6      | NA                | NA                | NA                              | NA                              |
| LVCMOS25R33           | -0.3                  | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | 3.6      | NA                | NA                | NA                              | NA                              |
| LVCMOS18R33           | -0.3                  | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | 3.6      | NA                | NA                | NA                              | NA                              |
| LVCMOS18R25           | -0.3                  | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | 3.6      | NA                | NA                | NA                              | NA                              |
| LVCMOS15R33           | -0.3                  | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | 3.6      | NA                | NA                | NA                              | NA                              |
| LVCMOS15R25           | -0.3                  | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | 3.6      | NA                | NA                | NA                              | NA                              |
| LVCMOS12R33           | -0.3                  | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | 3.6      | 0.40              | NA Open Drain     | 24, 16, 12, 8, 4                | NA Open Drain                   |
| LVCMOS12R25           | -0.3                  | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | 3.6      | 0.40              | NA Open Drain     | 16, 12, 8, 4                    | NA Open Drain                   |
| LVCMOS10R33           | -0.3                  | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | 3.6      | 0.40              | NA Open Drain     | 24, 16, 12, 8, 4                | NA Open Drain                   |

### RSDS

The MachXO2 family supports the differential RSDS standard. The output standard is emulated using complementary LVCMOS outputs in conjunction with resistors across the driver outputs on all the devices. The RSDS input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-4 is one possible solution for RSDS standard implementation. Use LVDS25E mode with suggested resistors for RSDS operation. Resistor values in Figure 3-4 are industry standard values for 1% resistors.

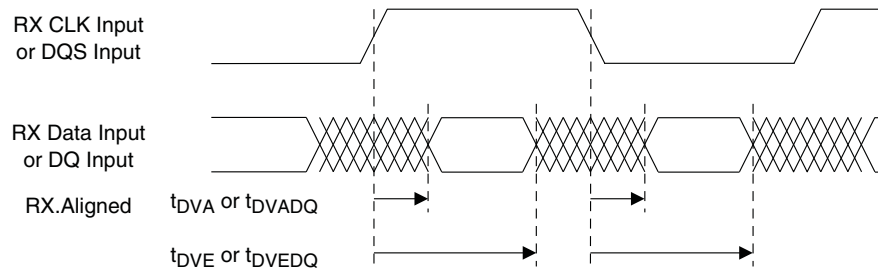
**Figure 3-4. RSDS (Reduced Swing Differential Standard)**



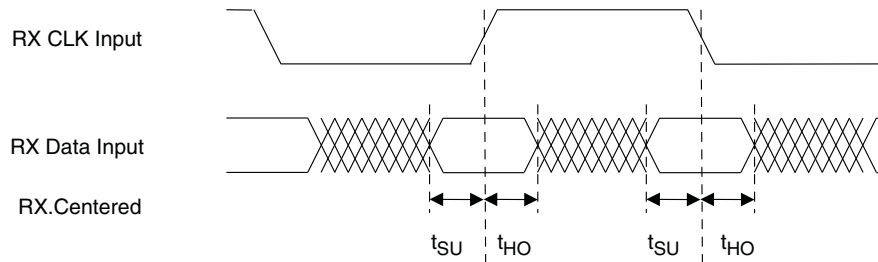
**Table 3-4. RSDS DC Conditions**

| Parameter  | Description                 | Typical | Units |
|------------|-----------------------------|---------|-------|
| $Z_{OUT}$  | Output impedance            | 20      | Ohms  |
| $R_S$      | Driver series resistor      | 294     | Ohms  |
| $R_P$      | Driver parallel resistor    | 121     | Ohms  |
| $R_T$      | Receiver termination        | 100     | Ohms  |
| $V_{OH}$   | Output high voltage         | 1.35    | V     |
| $V_{OL}$   | Output low voltage          | 1.15    | V     |
| $V_{OD}$   | Output differential voltage | 0.20    | V     |
| $V_{CM}$   | Output common mode voltage  | 1.25    | V     |
| $Z_{BACK}$ | Back impedance              | 101.5   | Ohms  |
| $I_{DC}$   | DC output current           | 3.66    | mA    |

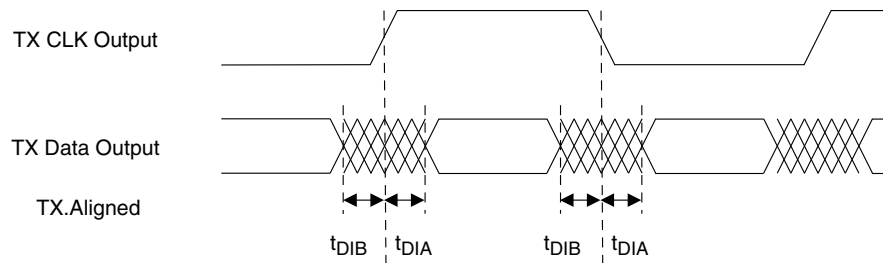
**Figure 3-5. Receiver RX.CLK.Aligned and MEM DDR Input Waveforms**



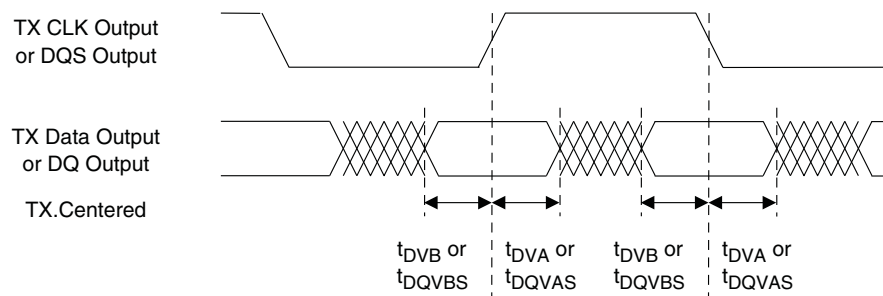
**Figure 3-6. Receiver RX.CLK.Centered Waveforms**



**Figure 3-7. Transmitter TX.CLK.Aligned Waveforms**



**Figure 3-8. Transmitter TX.CLK.Centered and MEM DDR Output Waveforms**



### sysCLOCK PLL Timing (Continued)

#### Over Recommended Operating Conditions

| Parameter               | Descriptions          | Conditions | Min. | Max. | Units      |
|-------------------------|-----------------------|------------|------|------|------------|
| $t_{\text{ROTATE\_WD}}$ | PHASESTEP Pulse Width |            | 4    | —    | VCO Cycles |

1. Period jitter sample is taken over 10,000 samples of the primary PLL output with a clean reference clock. Cycle-to-cycle jitter is taken over 1000 cycles. Phase jitter is taken over 2000 cycles. All values per JESD65B.
2. Output clock is valid after  $t_{\text{LOCK}}$  for PLL reset and dynamic delay adjustment.
3. Using LVDS output buffers.
4. CLKOS as compared to CLKOP output for one phase step at the maximum VCO frequency. See TN1199, [MachXO2 sysCLOCK PLL Design and Usage Guide](#) for more details.
5. At minimum  $f_{\text{PFD}}$ . As the  $f_{\text{PFD}}$  increases the time will decrease to approximately 60% the value listed.
6. Maximum allowed jitter on an input clock. PLL unlock may occur if the input jitter exceeds this specification. Jitter on the input clock may be transferred to the output clocks, resulting in jitter measurements outside the output specifications listed in this table.
7. Edge Duty Trim Accuracy is a percentage of the setting value. Settings available are 70 ps, 140 ps, and 280 ps in addition to the default value of none.
8. Jitter values measured with the internal oscillator operating. The jitter values will increase with loading of the PLD fabric and in the presence of SSO noise.

|                                                        | MachXO2-2000 |             |              |             |              |              | MachXO2-2000U |
|--------------------------------------------------------|--------------|-------------|--------------|-------------|--------------|--------------|---------------|
|                                                        | 49<br>WLCSP  | 100<br>TQFP | 132<br>csBGA | 144<br>TQFP | 256<br>caBGA | 256<br>ftBGA | 484 ftBGA     |
| <b>General Purpose I/O per Bank</b>                    |              |             |              |             |              |              |               |
| Bank 0                                                 | 19           | 18          | 25           | 27          | 50           | 50           | 70            |
| Bank 1                                                 | 0            | 21          | 26           | 28          | 52           | 52           | 68            |
| Bank 2                                                 | 13           | 20          | 28           | 28          | 52           | 52           | 72            |
| Bank 3                                                 | 0            | 6           | 7            | 8           | 16           | 16           | 24            |
| Bank 4                                                 | 0            | 6           | 8            | 10          | 16           | 16           | 16            |
| Bank 5                                                 | 6            | 8           | 10           | 10          | 20           | 20           | 28            |
| Total General Purpose Single-Ended I/O                 | 38           | 79          | 104          | 111         | 206          | 206          | 278           |
| <b>Differential I/O per Bank</b>                       |              |             |              |             |              |              |               |
| Bank 0                                                 | 7            | 9           | 13           | 14          | 25           | 25           | 35            |
| Bank 1                                                 | 0            | 10          | 13           | 14          | 26           | 26           | 34            |
| Bank 2                                                 | 6            | 10          | 14           | 14          | 26           | 26           | 36            |
| Bank 3                                                 | 0            | 3           | 3            | 4           | 8            | 8            | 12            |
| Bank 4                                                 | 0            | 3           | 4            | 5           | 8            | 8            | 8             |
| Bank 5                                                 | 3            | 4           | 5            | 5           | 10           | 10           | 14            |
| Total General Purpose Differential I/O                 | 16           | 39          | 52           | 56          | 103          | 103          | 139           |
| <b>Dual Function I/O</b>                               |              |             |              |             |              |              |               |
|                                                        | 24           | 31          | 33           | 33          | 33           | 33           | 37            |
| <b>High-speed Differential I/O</b>                     |              |             |              |             |              |              |               |
| Bank 0                                                 | 5            | 4           | 8            | 9           | 14           | 14           | 18            |
| <b>Gearboxes</b>                                       |              |             |              |             |              |              |               |
| Number of 7:1 or 8:1 Output Gearbox Available (Bank 0) | 5            | 4           | 8            | 9           | 14           | 14           | 18            |
| Number of 7:1 or 8:1 Input Gearbox Available (Bank 2)  | 6            | 10          | 14           | 14          | 14           | 14           | 18            |
| <b>DQS Groups</b>                                      |              |             |              |             |              |              |               |
| Bank 1                                                 | 0            | 1           | 2            | 2           | 2            | 2            | 2             |
| <b>VCCIO Pins</b>                                      |              |             |              |             |              |              |               |
| Bank 0                                                 | 2            | 2           | 3            | 3           | 4            | 4            | 10            |
| Bank 1                                                 | 0            | 2           | 3            | 3           | 4            | 4            | 10            |
| Bank 2                                                 | 1            | 2           | 3            | 3           | 4            | 4            | 10            |
| Bank 3                                                 | 0            | 1           | 1            | 1           | 1            | 1            | 3             |
| Bank 4                                                 | 0            | 1           | 1            | 1           | 2            | 2            | 4             |
| Bank 5                                                 | 1            | 1           | 1            | 1           | 1            | 1            | 3             |
| VCC                                                    | 2            | 2           | 4            | 4           | 8            | 8            | 12            |
| GND                                                    | 4            | 8           | 10           | 12          | 24           | 24           | 48            |
| NC                                                     | 0            | 1           | 1            | 4           | 1            | 1            | 105           |
| Reserved for Configuration                             | 1            | 1           | 1            | 1           | v            | 1            | 1             |
| Total Count of Bonded Pins                             | 39           | 100         | 132          | 144         | 256          | 256          | 484           |

|                                                        | MachXO2-7000 |           |           |           |           |           |
|--------------------------------------------------------|--------------|-----------|-----------|-----------|-----------|-----------|
|                                                        | 144 TQFP     | 256 caBGA | 256 ftBGA | 332 caBGA | 400 caBGA | 484 fpBGA |
| <b>General Purpose I/O per Bank</b>                    |              |           |           |           |           |           |
| Bank 0                                                 | 27           | 50        | 50        | 68        | 83        | 82        |
| Bank 1                                                 | 29           | 52        | 52        | 70        | 84        | 84        |
| Bank 2                                                 | 29           | 52        | 52        | 70        | 84        | 84        |
| Bank 3                                                 | 9            | 16        | 16        | 24        | 28        | 28        |
| Bank 4                                                 | 10           | 16        | 16        | 16        | 24        | 24        |
| Bank 5                                                 | 10           | 20        | 20        | 30        | 32        | 32        |
| Total General Purpose Single Ended I/O                 | 114          | 206       | 206       | 278       | 335       | 334       |
| <b>Differential I/O per Bank</b>                       |              |           |           |           |           |           |
| Bank 0                                                 | 14           | 25        | 25        | 34        | 42        | 41        |
| Bank 1                                                 | 14           | 26        | 26        | 35        | 42        | 42        |
| Bank 2                                                 | 14           | 26        | 26        | 35        | 42        | 42        |
| Bank 3                                                 | 4            | 8         | 8         | 12        | 14        | 14        |
| Bank 4                                                 | 5            | 8         | 8         | 8         | 12        | 12        |
| Bank 5                                                 | 5            | 10        | 10        | 15        | 16        | 16        |
| Total General Purpose Differential I/O                 | 56           | 103       | 103       | 139       | 168       | 167       |
| <b>Dual Function I/O</b>                               |              |           |           |           |           |           |
|                                                        | 37           | 37        | 37        | 37        | 37        | 37        |
| <b>High-speed Differential I/O</b>                     |              |           |           |           |           |           |
| Bank 0                                                 | 9            | 20        | 20        | 21        | 21        | 21        |
| <b>Gearboxes</b>                                       |              |           |           |           |           |           |
| Number of 7:1 or 8:1 Output Gearbox Available (Bank 0) | 9            | 20        | 20        | 21        | 21        | 21        |
| Number of 7:1 or 8:1 Input Gearbox Available (Bank 2)  | 14           | 20        | 20        | 21        | 21        | 21        |
| <b>DQS Groups</b>                                      |              |           |           |           |           |           |
| Bank 1                                                 | 2            | 2         | 2         | 2         | 2         | 2         |
| <b>VCCIO Pins</b>                                      |              |           |           |           |           |           |
| Bank 0                                                 | 3            | 4         | 4         | 4         | 5         | 10        |
| Bank 1                                                 | 3            | 4         | 4         | 4         | 5         | 10        |
| Bank 2                                                 | 3            | 4         | 4         | 4         | 5         | 10        |
| Bank 3                                                 | 1            | 1         | 1         | 2         | 2         | 3         |
| Bank 4                                                 | 1            | 2         | 2         | 1         | 2         | 4         |
| Bank 5                                                 | 1            | 1         | 1         | 2         | 2         | 3         |
|                                                        |              |           |           |           |           |           |
| VCC                                                    | 4            | 8         | 8         | 8         | 10        | 12        |
| GND                                                    | 12           | 24        | 24        | 27        | 33        | 48        |
| NC                                                     | 1            | 1         | 1         | 1         | 0         | 49        |
| Reserved for Configuration                             | 1            | 1         | 1         | 1         | 1         | 1         |
| Total Count of Bonded Pins                             | 144          | 256       | 256       | 332       | 400       | 484       |

| Part Number            | LUTs | Supply Voltage | Grade | Package            | Leads | Temp. |
|------------------------|------|----------------|-------|--------------------|-------|-------|
| LCMXO2-7000ZE-1TG144C  | 6864 | 1.2 V          | –1    | Halogen-Free TQFP  | 144   | COM   |
| LCMXO2-7000ZE-2TG144C  | 6864 | 1.2 V          | –2    | Halogen-Free TQFP  | 144   | COM   |
| LCMXO2-7000ZE-3TG144C  | 6864 | 1.2 V          | –3    | Halogen-Free TQFP  | 144   | COM   |
| LCMXO2-7000ZE-1BG256C  | 6864 | 1.2 V          | –1    | Halogen-Free caBGA | 256   | COM   |
| LCMXO2-7000ZE-2BG256C  | 6864 | 1.2 V          | –2    | Halogen-Free caBGA | 256   | COM   |
| LCMXO2-7000ZE-3BG256C  | 6864 | 1.2 V          | –3    | Halogen-Free caBGA | 256   | COM   |
| LCMXO2-7000ZE-1FTG256C | 6864 | 1.2 V          | –1    | Halogen-Free ftBGA | 256   | COM   |
| LCMXO2-7000ZE-2FTG256C | 6864 | 1.2 V          | –2    | Halogen-Free ftBGA | 256   | COM   |
| LCMXO2-7000ZE-3FTG256C | 6864 | 1.2 V          | –3    | Halogen-Free ftBGA | 256   | COM   |
| LCMXO2-7000ZE-1BG332C  | 6864 | 1.2 V          | –1    | Halogen-Free caBGA | 332   | COM   |
| LCMXO2-7000ZE-2BG332C  | 6864 | 1.2 V          | –2    | Halogen-Free caBGA | 332   | COM   |
| LCMXO2-7000ZE-3BG332C  | 6864 | 1.2 V          | –3    | Halogen-Free caBGA | 332   | COM   |
| LCMXO2-7000ZE-1FG484C  | 6864 | 1.2 V          | –1    | Halogen-Free fpBGA | 484   | COM   |
| LCMXO2-7000ZE-2FG484C  | 6864 | 1.2 V          | –2    | Halogen-Free fpBGA | 484   | COM   |
| LCMXO2-7000ZE-3FG484C  | 6864 | 1.2 V          | –3    | Halogen-Free fpBGA | 484   | COM   |

| Part Number                          | LUTs | Supply Voltage | Grade | Package            | Leads | Temp. |
|--------------------------------------|------|----------------|-------|--------------------|-------|-------|
| LCMXO2-1200ZE-1TG100CR1 <sup>1</sup> | 1280 | 1.2 V          | –1    | Halogen-Free TQFP  | 100   | COM   |
| LCMXO2-1200ZE-2TG100CR1 <sup>1</sup> | 1280 | 1.2 V          | –2    | Halogen-Free TQFP  | 100   | COM   |
| LCMXO2-1200ZE-3TG100CR1 <sup>1</sup> | 1280 | 1.2 V          | –3    | Halogen-Free TQFP  | 100   | COM   |
| LCMXO2-1200ZE-1MG132CR1 <sup>1</sup> | 1280 | 1.2 V          | –1    | Halogen-Free csBGA | 132   | COM   |
| LCMXO2-1200ZE-2MG132CR1 <sup>1</sup> | 1280 | 1.2 V          | –2    | Halogen-Free csBGA | 132   | COM   |
| LCMXO2-1200ZE-3MG132CR1 <sup>1</sup> | 1280 | 1.2 V          | –3    | Halogen-Free csBGA | 132   | COM   |
| LCMXO2-1200ZE-1TG144CR1 <sup>1</sup> | 1280 | 1.2 V          | –1    | Halogen-Free TQFP  | 144   | COM   |
| LCMXO2-1200ZE-2TG144CR1 <sup>1</sup> | 1280 | 1.2 V          | –2    | Halogen-Free TQFP  | 144   | COM   |
| LCMXO2-1200ZE-3TG144CR1 <sup>1</sup> | 1280 | 1.2 V          | –3    | Halogen-Free TQFP  | 144   | COM   |

1. Specifications for the “LCMXO2-1200ZE-speed package CR1” are the same as the “LCMXO2-1200ZE-speed package C” devices respectively, except as specified in the [R1 Device Specifications](#) section of this data sheet.

**High-Performance Commercial Grade Devices with Voltage Regulator, Halogen Free (RoHS) Packaging**

| Part Number          | LUTs | Supply Voltage | Grade | Package            | Leads | Temp. |
|----------------------|------|----------------|-------|--------------------|-------|-------|
| LCMXO2-256HC-4SG32C  | 256  | 2.5 V / 3.3 V  | –4    | Halogen-Free QFN   | 32    | COM   |
| LCMXO2-256HC-5SG32C  | 256  | 2.5 V / 3.3 V  | –5    | Halogen-Free QFN   | 32    | COM   |
| LCMXO2-256HC-6SG32C  | 256  | 2.5 V / 3.3 V  | –6    | Halogen-Free QFN   | 32    | COM   |
| LCMXO2-256HC-4SG48C  | 256  | 2.5 V / 3.3 V  | –4    | Halogen-Free QFN   | 48    | COM   |
| LCMXO2-256HC-5SG48C  | 256  | 2.5 V / 3.3 V  | –5    | Halogen-Free QFN   | 48    | COM   |
| LCMXO2-256HC-6SG48C  | 256  | 2.5 V / 3.3 V  | –6    | Halogen-Free QFN   | 48    | COM   |
| LCMXO2-256HC-4UMG64C | 256  | 2.5 V / 3.3 V  | –4    | Halogen-Free ucBGA | 64    | COM   |
| LCMXO2-256HC-5UMG64C | 256  | 2.5 V / 3.3 V  | –5    | Halogen-Free ucBGA | 64    | COM   |
| LCMXO2-256HC-6UMG64C | 256  | 2.5 V / 3.3 V  | –6    | Halogen-Free ucBGA | 64    | COM   |
| LCMXO2-256HC-4TG100C | 256  | 2.5 V / 3.3 V  | –4    | Halogen-Free TQFP  | 100   | COM   |
| LCMXO2-256HC-5TG100C | 256  | 2.5 V / 3.3 V  | –5    | Halogen-Free TQFP  | 100   | COM   |
| LCMXO2-256HC-6TG100C | 256  | 2.5 V / 3.3 V  | –6    | Halogen-Free TQFP  | 100   | COM   |
| LCMXO2-256HC-4MG132C | 256  | 2.5 V / 3.3 V  | –4    | Halogen-Free csBGA | 132   | COM   |
| LCMXO2-256HC-5MG132C | 256  | 2.5 V / 3.3 V  | –5    | Halogen-Free csBGA | 132   | COM   |
| LCMXO2-256HC-6MG132C | 256  | 2.5 V / 3.3 V  | –6    | Halogen-Free csBGA | 132   | COM   |

| Part Number          | LUTs | Supply Voltage | Grade | Package            | Leads | Temp. |
|----------------------|------|----------------|-------|--------------------|-------|-------|
| LCMXO2-640HC-4SG48C  | 640  | 2.5 V / 3.3 V  | –4    | Halogen-Free QFN   | 48    | COM   |
| LCMXO2-640HC-5SG48C  | 640  | 2.5 V / 3.3 V  | –5    | Halogen-Free QFN   | 48    | COM   |
| LCMXO2-640HC-6SG48C  | 640  | 2.5 V / 3.3 V  | –6    | Halogen-Free QFN   | 48    | COM   |
| LCMXO2-640HC-4TG100C | 640  | 2.5 V / 3.3 V  | –4    | Halogen-Free TQFP  | 100   | COM   |
| LCMXO2-640HC-5TG100C | 640  | 2.5 V / 3.3 V  | –5    | Halogen-Free TQFP  | 100   | COM   |
| LCMXO2-640HC-6TG100C | 640  | 2.5 V / 3.3 V  | –6    | Halogen-Free TQFP  | 100   | COM   |
| LCMXO2-640HC-4MG132C | 640  | 2.5 V / 3.3 V  | –4    | Halogen-Free csBGA | 132   | COM   |
| LCMXO2-640HC-5MG132C | 640  | 2.5 V / 3.3 V  | –5    | Halogen-Free csBGA | 132   | COM   |
| LCMXO2-640HC-6MG132C | 640  | 2.5 V / 3.3 V  | –6    | Halogen-Free csBGA | 132   | COM   |

| Part Number           | LUTs | Supply Voltage | Grade | Package           | Leads | Temp. |
|-----------------------|------|----------------|-------|-------------------|-------|-------|
| LCMXO2-640UHC-4TG144C | 640  | 2.5 V / 3.3 V  | –4    | Halogen-Free TQFP | 144   | COM   |
| LCMXO2-640UHC-5TG144C | 640  | 2.5 V / 3.3 V  | –5    | Halogen-Free TQFP | 144   | COM   |
| LCMXO2-640UHC-6TG144C | 640  | 2.5 V / 3.3 V  | –6    | Halogen-Free TQFP | 144   | COM   |



| Part Number           | LUTs | Supply Voltage | Grade | Package            | Leads | Temp. |
|-----------------------|------|----------------|-------|--------------------|-------|-------|
| LCMXO2-1200HC-4SG32C  | 1280 | 2.5 V / 3.3 V  | –4    | Halogen-Free QFN   | 32    | COM   |
| LCMXO2-1200HC-5SG32C  | 1280 | 2.5 V / 3.3 V  | –5    | Halogen-Free QFN   | 32    | COM   |
| LCMXO2-1200HC-6SG32C  | 1280 | 2.5 V / 3.3 V  | –6    | Halogen-Free QFN   | 32    | COM   |
| LCMXO2-1200HC-4TG100C | 1280 | 2.5 V / 3.3 V  | –4    | Halogen-Free TQFP  | 100   | COM   |
| LCMXO2-1200HC-5TG100C | 1280 | 2.5 V / 3.3 V  | –5    | Halogen-Free TQFP  | 100   | COM   |
| LCMXO2-1200HC-6TG100C | 1280 | 2.5 V / 3.3 V  | –6    | Halogen-Free TQFP  | 100   | COM   |
| LCMXO2-1200HC-4MG132C | 1280 | 2.5 V / 3.3 V  | –4    | Halogen-Free csBGA | 132   | COM   |
| LCMXO2-1200HC-5MG132C | 1280 | 2.5 V / 3.3 V  | –5    | Halogen-Free csBGA | 132   | COM   |
| LCMXO2-1200HC-6MG132C | 1280 | 2.5 V / 3.3 V  | –6    | Halogen-Free csBGA | 132   | COM   |
| LCMXO2-1200HC-4TG144C | 1280 | 2.5 V / 3.3 V  | –4    | Halogen-Free TQFP  | 144   | COM   |
| LCMXO2-1200HC-5TG144C | 1280 | 2.5 V / 3.3 V  | –5    | Halogen-Free TQFP  | 144   | COM   |
| LCMXO2-1200HC-6TG144C | 1280 | 2.5 V / 3.3 V  | –6    | Halogen-Free TQFP  | 144   | COM   |

| Part Number             | LUTs | Supply Voltage | Grade | Package            | Leads | Temp. |
|-------------------------|------|----------------|-------|--------------------|-------|-------|
| LCMXO2-1200UHC-4FTG256C | 1280 | 2.5 V / 3.3 V  | –4    | Halogen-Free ftBGA | 256   | COM   |
| LCMXO2-1200UHC-5FTG256C | 1280 | 2.5 V / 3.3 V  | –5    | Halogen-Free ftBGA | 256   | COM   |
| LCMXO2-1200UHC-6FTG256C | 1280 | 2.5 V / 3.3 V  | –6    | Halogen-Free ftBGA | 256   | COM   |

| Part Number            | LUTs | Supply Voltage | Grade | Package            | Leads | Temp. |
|------------------------|------|----------------|-------|--------------------|-------|-------|
| LCMXO2-2000HC-4TG100C  | 2112 | 2.5 V / 3.3 V  | –4    | Halogen-Free TQFP  | 100   | COM   |
| LCMXO2-2000HC-5TG100C  | 2112 | 2.5 V / 3.3 V  | –5    | Halogen-Free TQFP  | 100   | COM   |
| LCMXO2-2000HC-6TG100C  | 2112 | 2.5 V / 3.3 V  | –6    | Halogen-Free TQFP  | 100   | COM   |
| LCMXO2-2000HC-4MG132C  | 2112 | 2.5 V / 3.3 V  | –4    | Halogen-Free csBGA | 132   | COM   |
| LCMXO2-2000HC-5MG132C  | 2112 | 2.5 V / 3.3 V  | –5    | Halogen-Free csBGA | 132   | COM   |
| LCMXO2-2000HC-6MG132C  | 2112 | 2.5 V / 3.3 V  | –6    | Halogen-Free csBGA | 132   | COM   |
| LCMXO2-2000HC-4TG144C  | 2112 | 2.5 V / 3.3 V  | –4    | Halogen-Free TQFP  | 144   | COM   |
| LCMXO2-2000HC-5TG144C  | 2112 | 2.5 V / 3.3 V  | –5    | Halogen-Free TQFP  | 144   | COM   |
| LCMXO2-2000HC-6TG144C  | 2112 | 2.5 V / 3.3 V  | –6    | Halogen-Free TQFP  | 144   | COM   |
| LCMXO2-2000HC-4BG256C  | 2112 | 2.5 V / 3.3 V  | –4    | Halogen-Free caBGA | 256   | COM   |
| LCMXO2-2000HC-5BG256C  | 2112 | 2.5 V / 3.3 V  | –5    | Halogen-Free caBGA | 256   | COM   |
| LCMXO2-2000HC-6BG256C  | 2112 | 2.5 V / 3.3 V  | –6    | Halogen-Free caBGA | 256   | COM   |
| LCMXO2-2000HC-4FTG256C | 2112 | 2.5 V / 3.3 V  | –4    | Halogen-Free ftBGA | 256   | COM   |
| LCMXO2-2000HC-5FTG256C | 2112 | 2.5 V / 3.3 V  | –5    | Halogen-Free ftBGA | 256   | COM   |
| LCMXO2-2000HC-6FTG256C | 2112 | 2.5 V / 3.3 V  | –6    | Halogen-Free ftBGA | 256   | COM   |

**Ultra Low Power Industrial Grade Devices, Halogen Free (RoHS) Packaging**

| Part Number          | LUTs | Supply Voltage | Grade | Package            | Leads | Temp. |
|----------------------|------|----------------|-------|--------------------|-------|-------|
| LCMXO2-256ZE-1SG32I  | 256  | 1.2 V          | –1    | Halogen-Free QFN   | 32    | IND   |
| LCMXO2-256ZE-2SG32I  | 256  | 1.2 V          | –2    | Halogen-Free QFN   | 32    | IND   |
| LCMXO2-256ZE-3SG32I  | 256  | 1.2 V          | –3    | Halogen-Free QFN   | 32    | IND   |
| LCMXO2-256ZE-1UMG64I | 256  | 1.2 V          | –1    | Halogen-Free ucBGA | 64    | IND   |
| LCMXO2-256ZE-2UMG64I | 256  | 1.2 V          | –2    | Halogen-Free ucBGA | 64    | IND   |
| LCMXO2-256ZE-3UMG64I | 256  | 1.2 V          | –3    | Halogen-Free ucBGA | 64    | IND   |
| LCMXO2-256ZE-1TG100I | 256  | 1.2 V          | –1    | Halogen-Free TQFP  | 100   | IND   |
| LCMXO2-256ZE-2TG100I | 256  | 1.2 V          | –2    | Halogen-Free TQFP  | 100   | IND   |
| LCMXO2-256ZE-3TG100I | 256  | 1.2 V          | –3    | Halogen-Free TQFP  | 100   | IND   |
| LCMXO2-256ZE-1MG132I | 256  | 1.2 V          | –1    | Halogen-Free csBGA | 132   | IND   |
| LCMXO2-256ZE-2MG132I | 256  | 1.2 V          | –2    | Halogen-Free csBGA | 132   | IND   |
| LCMXO2-256ZE-3MG132I | 256  | 1.2 V          | –3    | Halogen-Free csBGA | 132   | IND   |

| Part Number          | LUTs | Supply Voltage | Grade | Package            | Leads | Temp. |
|----------------------|------|----------------|-------|--------------------|-------|-------|
| LCMXO2-640ZE-1TG100I | 640  | 1.2 V          | –1    | Halogen-Free TQFP  | 100   | IND   |
| LCMXO2-640ZE-2TG100I | 640  | 1.2 V          | –2    | Halogen-Free TQFP  | 100   | IND   |
| LCMXO2-640ZE-3TG100I | 640  | 1.2 V          | –3    | Halogen-Free TQFP  | 100   | IND   |
| LCMXO2-640ZE-1MG132I | 640  | 1.2 V          | –1    | Halogen-Free csBGA | 132   | IND   |
| LCMXO2-640ZE-2MG132I | 640  | 1.2 V          | –2    | Halogen-Free csBGA | 132   | IND   |
| LCMXO2-640ZE-3MG132I | 640  | 1.2 V          | –3    | Halogen-Free csBGA | 132   | IND   |

| Part Number                            | LUTs | Supply Voltage | Grade | Package            | Leads | Temp. |
|----------------------------------------|------|----------------|-------|--------------------|-------|-------|
| LCMXO2-1200ZE-1UWG25ITR <sup>1</sup>   | 1280 | 1.2 V          | –1    | Halogen-Free WLCSP | 25    | IND   |
| LCMXO2-1200ZE-1UWG25ITR50 <sup>3</sup> | 1280 | 1.2 V          | –1    | Halogen-Free WLCSP | 25    | IND   |
| LCMXO2-1200ZE-1UWG25ITR1K <sup>2</sup> | 1280 | 1.2 V          | –1    | Halogen-Free WLCSP | 25    | IND   |
| LCMXO2-1200ZE-1SG32I                   | 1280 | 1.2 V          | –1    | Halogen-Free QFN   | 32    | IND   |
| LCMXO2-1200ZE-2SG32I                   | 1280 | 1.2 V          | –2    | Halogen-Free QFN   | 32    | IND   |
| LCMXO2-1200ZE-3SG32I                   | 1280 | 1.2 V          | –3    | Halogen-Free QFN   | 32    | IND   |
| LCMXO2-1200ZE-1TG100I                  | 1280 | 1.2 V          | –1    | Halogen-Free TQFP  | 100   | IND   |
| LCMXO2-1200ZE-2TG100I                  | 1280 | 1.2 V          | –2    | Halogen-Free TQFP  | 100   | IND   |
| LCMXO2-1200ZE-3TG100I                  | 1280 | 1.2 V          | –3    | Halogen-Free TQFP  | 100   | IND   |
| LCMXO2-1200ZE-1MG132I                  | 1280 | 1.2 V          | –1    | Halogen-Free csBGA | 132   | IND   |
| LCMXO2-1200ZE-2MG132I                  | 1280 | 1.2 V          | –2    | Halogen-Free csBGA | 132   | IND   |
| LCMXO2-1200ZE-3MG132I                  | 1280 | 1.2 V          | –3    | Halogen-Free csBGA | 132   | IND   |
| LCMXO2-1200ZE-1TG144I                  | 1280 | 1.2 V          | –1    | Halogen-Free TQFP  | 144   | IND   |
| LCMXO2-1200ZE-2TG144I                  | 1280 | 1.2 V          | –2    | Halogen-Free TQFP  | 144   | IND   |
| LCMXO2-1200ZE-3TG144I                  | 1280 | 1.2 V          | –3    | Halogen-Free TQFP  | 144   | IND   |

1. This part number has a tape and reel quantity of 5,000 units with a minimum order quantity of 10,000 units. Order quantities must be in increments of 5,000 units. For example, a 10,000 unit order will be shipped in two reels with one reel containing 5,000 units and the other reel with less than 5,000 units (depending on test yields). Unserviced backlog will be canceled.
2. This part number has a tape and reel quantity of 1,000 units with a minimum order quantity of 1,000. Order quantities must be in increments of 1,000 units. For example, a 5,000 unit order will be shipped as 5 reels of 1000 units each.
3. This part number has a tape and reel quantity of 50 units with a minimum order quantity of 50. Order quantities must be in increments of 50 units. For example, a 1,000 unit order will be shipped as 20 reels of 50 units each.

| Part Number                            | LUTs | Supply Voltage | Grade | Package            | Leads | Temp. |
|----------------------------------------|------|----------------|-------|--------------------|-------|-------|
| LCMXO2-2000ZE-1UWG49ITR <sup>1</sup>   | 2112 | 1.2 V          | –1    | Halogen-Free WLCSP | 49    | IND   |
| LCMXO2-2000ZE-1UWG49ITR50 <sup>3</sup> | 2112 | 1.2 V          | –1    | Halogen-Free WLCSP | 49    | IND   |
| LCMXO2-2000ZE-1UWG49ITR1K <sup>2</sup> | 2112 | 1.2 V          | –1    | Halogen-Free WLCSP | 49    | IND   |
| LCMXO2-2000ZE-1TG100I                  | 2112 | 1.2 V          | –1    | Halogen-Free TQFP  | 100   | IND   |
| LCMXO2-2000ZE-2TG100I                  | 2112 | 1.2 V          | –2    | Halogen-Free TQFP  | 100   | IND   |
| LCMXO2-2000ZE-3TG100I                  | 2112 | 1.2 V          | –3    | Halogen-Free TQFP  | 100   | IND   |
| LCMXO2-2000ZE-1MG132I                  | 2112 | 1.2 V          | –1    | Halogen-Free csBGA | 132   | IND   |
| LCMXO2-2000ZE-2MG132I                  | 2112 | 1.2 V          | –2    | Halogen-Free csBGA | 132   | IND   |
| LCMXO2-2000ZE-3MG132I                  | 2112 | 1.2 V          | –3    | Halogen-Free csBGA | 132   | IND   |
| LCMXO2-2000ZE-1TG144I                  | 2112 | 1.2 V          | –1    | Halogen-Free TQFP  | 144   | IND   |
| LCMXO2-2000ZE-2TG144I                  | 2112 | 1.2 V          | –2    | Halogen-Free TQFP  | 144   | IND   |
| LCMXO2-2000ZE-3TG144I                  | 2112 | 1.2 V          | –3    | Halogen-Free TQFP  | 144   | IND   |
| LCMXO2-2000ZE-1BG256I                  | 2112 | 1.2 V          | –1    | Halogen-Free caBGA | 256   | IND   |
| LCMXO2-2000ZE-2BG256I                  | 2112 | 1.2 V          | –2    | Halogen-Free caBGA | 256   | IND   |
| LCMXO2-2000ZE-3BG256I                  | 2112 | 1.2 V          | –3    | Halogen-Free caBGA | 256   | IND   |
| LCMXO2-2000ZE-1FTG256I                 | 2112 | 1.2 V          | –1    | Halogen-Free ftBGA | 256   | IND   |
| LCMXO2-2000ZE-2FTG256I                 | 2112 | 1.2 V          | –2    | Halogen-Free ftBGA | 256   | IND   |
| LCMXO2-2000ZE-3FTG256I                 | 2112 | 1.2 V          | –3    | Halogen-Free ftBGA | 256   | IND   |

1. This part number has a tape and reel quantity of 5,000 units with a minimum order quantity of 10,000 units. Order quantities must be in increments of 5,000 units. For example, a 10,000 unit order will be shipped in two reels with one reel containing 5,000 units and the other reel with less than 5,000 units (depending on test yields). Unserviced backlog will be canceled.
2. This part number has a tape and reel quantity of 1,000 units with a minimum order quantity of 1,000. Order quantities must be in increments of 1,000 units. For example, a 5,000 unit order will be shipped as 5 reels of 1000 units each.
3. This part number has a tape and reel quantity of 50 units with a minimum order quantity of 50. Order quantities must be in increments of 50 units. For example, a 1,000 unit order will be shipped as 20 reels of 50 units each.

**High Performance Industrial Grade Devices Without Voltage Regulator, Halogen Free (RoHS) Packaging**

| Part Number            | LUTs | Supply Voltage | Grade | Package            | Leads | Temp. |
|------------------------|------|----------------|-------|--------------------|-------|-------|
| LCMXO2-2000HE-4TG100I  | 2112 | 1.2 V          | –4    | Halogen-Free TQFP  | 100   | IND   |
| LCMXO2-2000HE-5TG100I  | 2112 | 1.2 V          | –5    | Halogen-Free TQFP  | 100   | IND   |
| LCMXO2-2000HE-6TG100I  | 2112 | 1.2 V          | –6    | Halogen-Free TQFP  | 100   | IND   |
| LCMXO2-2000HE-4MG132I  | 2112 | 1.2 V          | –4    | Halogen-Free csBGA | 132   | IND   |
| LCMXO2-2000HE-5MG132I  | 2112 | 1.2 V          | –5    | Halogen-Free csBGA | 132   | IND   |
| LCMXO2-2000HE-6MG132I  | 2112 | 1.2 V          | –6    | Halogen-Free csBGA | 132   | IND   |
| LCMXO2-2000HE-4TG144I  | 2112 | 1.2 V          | –4    | Halogen-Free TQFP  | 144   | IND   |
| LCMXO2-2000HE-5TG144I  | 2112 | 1.2 V          | –5    | Halogen-Free TQFP  | 144   | IND   |
| LCMXO2-2000HE-6TG144I  | 2112 | 1.2 V          | –6    | Halogen-Free TQFP  | 144   | IND   |
| LCMXO2-2000HE-4BG256I  | 2112 | 1.2 V          | –4    | Halogen-Free caBGA | 256   | IND   |
| LCMXO2-2000HE-5BG256I  | 2112 | 1.2 V          | –5    | Halogen-Free caBGA | 256   | IND   |
| LCMXO2-2000HE-6BG256I  | 2112 | 1.2 V          | –6    | Halogen-Free caBGA | 256   | IND   |
| LCMXO2-2000HE-4FTG256I | 2112 | 1.2 V          | –4    | Halogen-Free ftBGA | 256   | IND   |
| LCMXO2-2000HE-5FTG256I | 2112 | 1.2 V          | –5    | Halogen-Free ftBGA | 256   | IND   |
| LCMXO2-2000HE-6FTG256I | 2112 | 1.2 V          | –6    | Halogen-Free ftBGA | 256   | IND   |

| Part Number            | LUTs | Supply Voltage | Grade | Package            | Leads | Temp. |
|------------------------|------|----------------|-------|--------------------|-------|-------|
| LCMXO2-2000UHE-4FG484I | 2112 | 1.2 V          | –4    | Halogen-Free fpBGA | 484   | IND   |
| LCMXO2-2000UHE-5FG484I | 2112 | 1.2 V          | –5    | Halogen-Free fpBGA | 484   | IND   |
| LCMXO2-2000UHE-6FG484I | 2112 | 1.2 V          | –6    | Halogen-Free fpBGA | 484   | IND   |

# MachXO2 Family Data Sheet

## Revision History

March 2017

Data Sheet DS1035

| Date       | Version              | Section                          | Change Summary                                                                                                                                                                                                                                                                                                       |
|------------|----------------------|----------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| March 2017 | 3.3                  | DC and Switching Characteristics | Updated the <a href="#">Absolute Maximum Ratings</a> section. Added standards.                                                                                                                                                                                                                                       |
|            |                      |                                  | Updated the <a href="#">sysIO Recommended Operating Conditions</a> section. Added standards.                                                                                                                                                                                                                         |
|            |                      |                                  | Updated the <a href="#">sysIO Single-Ended DC Electrical Characteristics</a> section. Added standards.                                                                                                                                                                                                               |
|            |                      |                                  | Updated the <a href="#">MachXO2 External Switching Characteristics – HC/HE Devices</a> section. Under 7:1 LVDS Outputs – GDDR71_TX.ECLK.7:1, the $D_{VB}$ and the $D_{VA}$ parameters were changed to $D_{IB}$ and $D_{IA}$ . The parameter descriptions were also modified.                                         |
|            |                      |                                  | Updated the <a href="#">MachXO2 External Switching Characteristics – ZE Devices</a> section. Under 7:1 LVDS Outputs – GDDR71_TX.ECLK.7:1, the $D_{VB}$ and the $D_{VA}$ parameters were changed to $D_{IB}$ and $D_{IA}$ . The parameter descriptions were also modified.                                            |
|            |                      |                                  | Updated the <a href="#">sysCONFIG Port Timing Specifications</a> section. Corrected the $t_{INITL}$ units from ns to $\mu$ s.                                                                                                                                                                                        |
|            | Pinout Information   | Pinout Information               | Updated the <a href="#">Signal Descriptions</a> section. Revised the descriptions of the PROGRAMN, INITN, and DONE signals.                                                                                                                                                                                          |
|            |                      |                                  | Updated the <a href="#">Pinout Information Summary</a> section. Added footnote to MachXO2-1200 32 QFN.                                                                                                                                                                                                               |
|            | Ordering Information | Ordering Information             | Updated the <a href="#">MachXO2 Part Number Description</a> section. Corrected the MG184, BG256, FTG256 package information. Added “(0.8 mm Pitch)” to BG332.                                                                                                                                                        |
|            |                      |                                  | Updated the <a href="#">Ultra Low Power Industrial Grade Devices, Halogen Free (RoHS) Packaging</a> section.<br>— Updated LCMXO2-1200ZE-1UWG25ITR50 footnote.<br>— Corrected footnote numbering typo.<br>— Added the LCMXO2-2000ZE-1UWG49ITR50 and LCMXO2-2000ZE-1UWG49ITR1K part numbers. Updated/added footnote/s. |